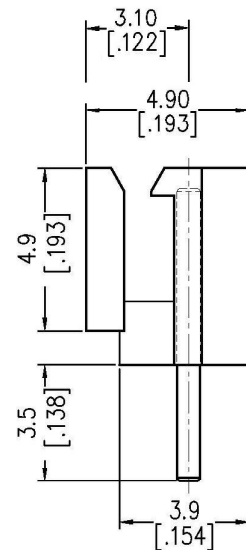
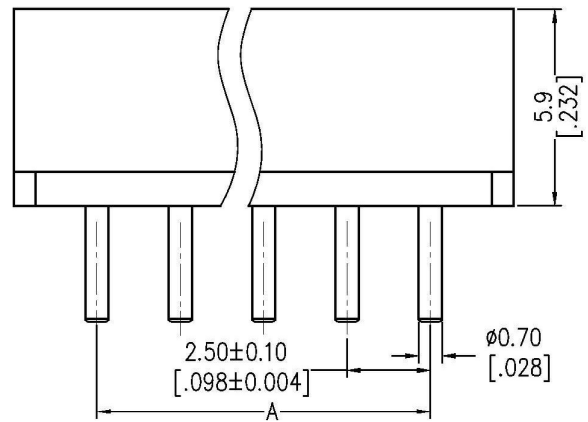
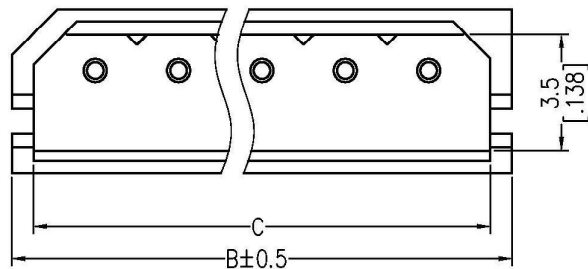


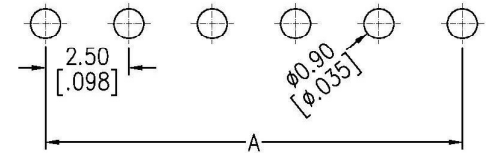
HSF

NOTES:
 Current Rating: 3.0AMP
 Contact Resistance: 20mΩ max
 Withstand Voltage: 800V AC/Minute
 Insulation Resistance: 1000MΩ min
 Operation Temperature: -25°C to +85°C

Contact Material: Brass
 Contact Plating: Au or Sn over Ni
 Insulator Material: PA66 UL94V-0



Recommended P.C.B Layout (Top Side)
 (PCB BOARD TOLERANCE ±0.05)



Specification & Ordering Information:

Circuit	Part No.	Dimension		
		A	B	C
02	HCA2567-02	2.5	7.4	6.0
03	HCA2567-03	5.0	9.9	8.5
04	HCA2567-04	7.5	12.4	11.0
05	HCA2567-05	10.0	14.9	13.5
06	HCA2567-06	12.5	17.4	16.0
07	HCA2567-07	15.0	19.9	18.5
08	HCA2567-08	17.5	22.4	21.0
09	HCA2567-09	20.0	24.9	23.5
10	HCA2567-10	22.5	27.4	26.0
11	HCA2567-11	25.0	29.9	28.5
12	HCA2567-12	27.5	32.4	31.0
13	HCA2567-13	30.0	34.9	33.5
14	HCA2567-14	32.5	37.4	36.0
15	HCA2567-15	35.0	39.9	38.5
16	HCA2567-16	37.5	42.4	41.0
17	HCA2567-17	40.0	44.9	43.5
18	HCA2567-18	42.5	47.4	46.0
19	HCA2567-19	45.0	49.9	48.5
20	HCA2567-20	47.5	52.4	51.0

Ordering Information

HCA2567-XX

No. of pins
02P~20P

REV	DATE	MODIFICATION DESCRIPTION	CHANGE	OPERATION		DRAW	DATE	SCALE	FIT	PART NO.
				Angle	TOL					
				X.X	±0.40	CHECK	DATE	mm		TITLE: 2.50 WAFER 180°
				X.XX	±0.25			inch		
				X.XXX	±0.15					
					± 3°	APPROVE	DATE	SHEET	1/1	Customer NO.
								PROJ.		

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